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BCW89

PNP General Purpose Amplifier

- This device is designed for general purpose medium power amplifiers and switches requiring collector currents to 300mA.
- Sourced from process 68.



1. Base 2. Emitter 3. Collector

Absolute Maximum Ratings * $T_C=25$ °C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	-60	V
V _{CES}	Collector-Emitter Voltage	-60	V
V _{EBO}	Emitter-Base Voltage	-5.0	V
I _C	Collector current - Continuous	-500	mA
T _J , T _{stg}	Junction and Storage Temperature	-55 ~ +150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- NOTES:

 1) These ratings are based on a maximum junction temperature of 150 degrees C.

 2) These are state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Charac	teristics		•		
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = -10\mu A, I_E = 0$	-80		V
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	$I_C = -2.0 \text{mA}, I_B = 0$	-60		V
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	$I_C = -10\mu A, I_E = 0$	-60		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_C = -10\mu A, I_C = 0$	-5.0		V
I _{CBO}	Collector Cutoff Current	$V_{CB} = -20V, I_{E} = 0$ $V_{CB} = -20V, I_{F} = 0, T_{A} = +100^{\circ}C$		-100 -10	nA μA
On Charac	teristics	- TOB - 201, 1E - 0, 1A - 1100 0	1		μι
h _{FE}	DC Current Gain	$V_{CE} = -5.0V, I_{C} = -2.0mA$	120	260	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = -10mA, I _B = -0.5mA		-0.3	V
V _{BE(on)}	Base-Emitter On Voltage	$V_{CE} = -5.0V, I_{C} = -2.0mA$	-0.6	-0.75	V
	al Characteristics		•		
NF	Noise Figure	$V_{CE} = -5.0V, I_{C} = -200\mu A$ $R_{S} = 2.0k\Omega, f = 1.0kHz$ $B_{W} = 200Hz$		10	dB

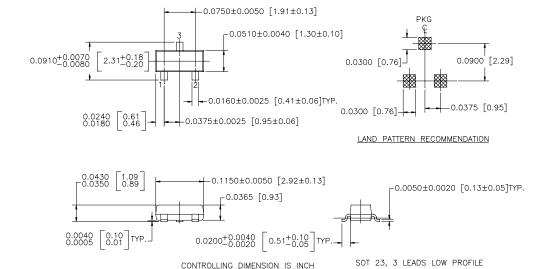
Thermal Characteristics $T_A=25$ °C unless otherwise noted

Symbol	Parameter	Max.	Units
P _D	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

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Package Dimensions

SOT-23



NOTE: UNLESS OTHERWISE SPECIFIED

- 1. STANDARD LEAD FINISH 150 MICROINCHES / 3.81 MICROMETERS MINIMUM TIN / LEAD (SOLDER) ON ALLOY 42
- 2. REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE G, DATED JUL 1993

Dimensions in Millimeters

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